

# 4N60K-TC

**Power MOSFET**

## 4A, 600V N-CHANNEL POWER MOSFET

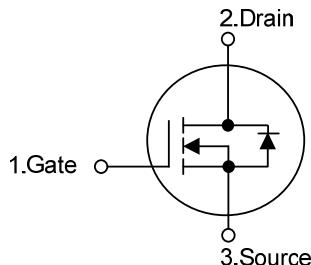
### ■ DESCRIPTION

The UTC **4N60K-TC** is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient AC to DC converters and bridge circuits.

### ■ FEATURES

- \*  $R_{DS(ON)} \leq 2.2 \Omega$  @  $V_{GS}=10V$ ,  $I_D=2.0A$
- \* Fast Switching Capability
- \* Avalanche Energy Specified
- \* Improved dv/dt Capability, high Ruggedness

### ■ SYMBOL



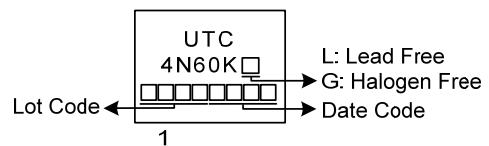
### ■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
4N60KL-TA3-T	4N60KG-TA3-T	TO-220	G	D	S	Tube
4N60KL-TF3-T	4N60KG-TF3-T	TO-220F	G	D	S	Tube
4N60KL-TF1-T	4N60KG-TF1-T	TO-220F1	G	D	S	Tube
4N60KL-TF2-T	4N60KG-TF2-T	TO-220F2	G	D	S	Tube
4N60KL-TF3T-T	4N60KG-TF3T-T	TO-220F3	G	D	S	Tube
4N60KL-TM3-T	4N60KG-TM3-T	TO-251	G	D	S	Tube
4N60KL-TN3-R	4N60KG-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

4N60KG-TA3-T	(1)T: Tube, R: Tape Reel (2)TA3: TO-220, TF3: TO-220F, TF1: TO-220F1, TF2: TO-220F2, TF3T: TO-220F3, TM3: TO-251, TN3: TO-252 (3) G: Halogen Free and Lead Free, L: Lead Free
--------------	---

## ■ MARKING



■ ABSOLUTE MAXIMUM RATINGS ( $T_c = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	600	V
Gate-Source Voltage		$V_{GSS}$	$\pm 30$	V
Avalanche Current (Note 2)		$I_{AR}$	4.0	A
Drain Current	Continuous	$I_D$	4.0	A
	Pulsed (Note 2)	$I_{DM}$	16	A
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	100	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	1.5	V/ns
Power Dissipation	TO-220	$P_D$	106	W
	TO-220F/TO-220F1		36	W
	TO-220F2/TO-220F3		50	W
	TO-251/TO-252		0.85	W/°C
Derate above 25°C	TO-220		0.288	W/°C
	TO-220F/TO-220F1		0.40	W/°C
	TO-220F2/TO-220F3			
	TO-251/TO-252			
Junction Temperature	$T_J$		+150	°C
Operating Temperature	$T_{OPR}$		-55 ~ +150	°C
Storage Temperature	$T_{STG}$		-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature

3.  $L = 13\text{mH}$ ,  $I_{AS} = 4.0\text{A}$ ,  $V_{DD} = 50\text{V}$ ,  $R_G = 25\ \Omega$ , Starting  $T_J = 25^\circ\text{C}$

4.  $I_{SD} \leq 4.0\text{A}$ ,  $di/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$

## ■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/TO-220F	$\theta_{JA}$	62.5	°C/W
	TO-220F1/TO-220F2			
	TO-220F3		110	°C/W
	TO-251/TO-252			
Junction to Case	TO-220	$\theta_{JC}$	1.18	°C/W
	TO-220F/TO-220F1		3.47	°C/W
	TO-220F3		3.4	°C/W
	TO-220F2			
	TO-251/TO-252		2.5	°C/W

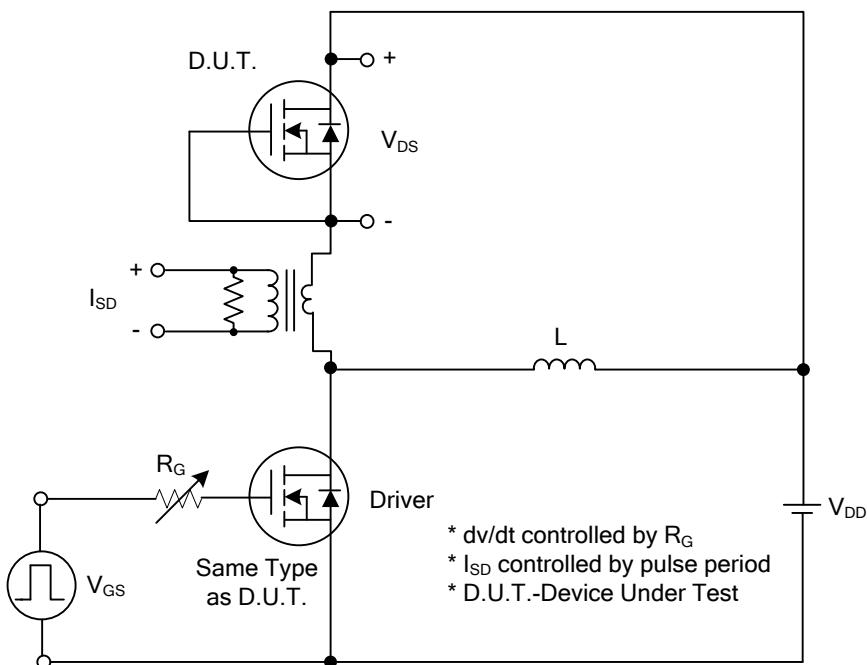
■ ELECTRICAL CHARACTERISTICS ( $T_C = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	600			V
Drain-Source Leakage Current	$I_{\text{DSS}}$	$V_{\text{DS}}=600\text{V}, V_{\text{GS}}=0\text{V}$		10		$\mu\text{A}$
		$V_{\text{DS}}=600\text{V}, V_{\text{GS}}=0\text{V}, T_C=125^\circ\text{C}$		10		$\mu\text{A}$
Gate-Source Leakage Current	$I_{\text{GSS}}$	$V_{\text{GS}}=30\text{V}, V_{\text{DS}}=0\text{V}$		100		nA
		$V_{\text{GS}}= -30\text{V}, V_{\text{DS}}=0\text{V}$		-100		nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{\text{GS(TH)}}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2.0		4.0	V
Static Drain-Source On-State Resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=2.0\text{A}$		2.0	2.2	$\Omega$
<b>DYNAMIC CHARACTERISTICS</b>						
Input Capacitance	$C_{\text{ISS}}$	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$		510		pF
Output Capacitance	$C_{\text{OSS}}$			58		pF
Reverse Transfer Capacitance	$C_{\text{RSS}}$			5.6		pF
<b>SWITCHING CHARACTERISTICS</b>						
Total Gate Charge	$Q_G$	$V_{\text{DS}}=480\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}}=4.0\text{A}$ $I_G = 1\text{mA}$ (Note1, 2)		13		nC
Gate-Source Charge	$Q_{\text{GS}}$			4		nC
Gate-Drain Charge	$Q_{\text{GD}}$			2.5		nC
Turn-On Delay Time	$t_{\text{D(ON)}}$	$V_{\text{DS}}=100\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}}=4.0\text{A}, R_G=25\Omega$ (Note1, 2)		4		ns
Turn-On Rise Time	$t_R$			18		ns
Turn-Off Delay Time	$t_{\text{D(OFF)}}$			38		ns
Turn-Off Fall Time	$t_F$			26		ns
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Maximum Continuous Drain-Source Diode Forward Current	$I_S$				4.0	A
Maximum Pulsed Drain-Source Diode Forward Current	$I_{\text{SM}}$				16	A
Drain-Source Diode Forward Voltage	$V_{\text{SD}}$	$I_S=4.0\text{A}, V_{\text{GS}}=0\text{V}$			1.4	V
Reverse Recovery Time	$t_{\text{rr}}$	$I_S=4.0\text{A}, V_{\text{GS}}=0\text{V}, \frac{di}{dt}=100\text{A}/\mu\text{s}$		300		nS
Reverse Recovery Charge	$Q_{\text{rr}}$			2.9		$\mu\text{C}$

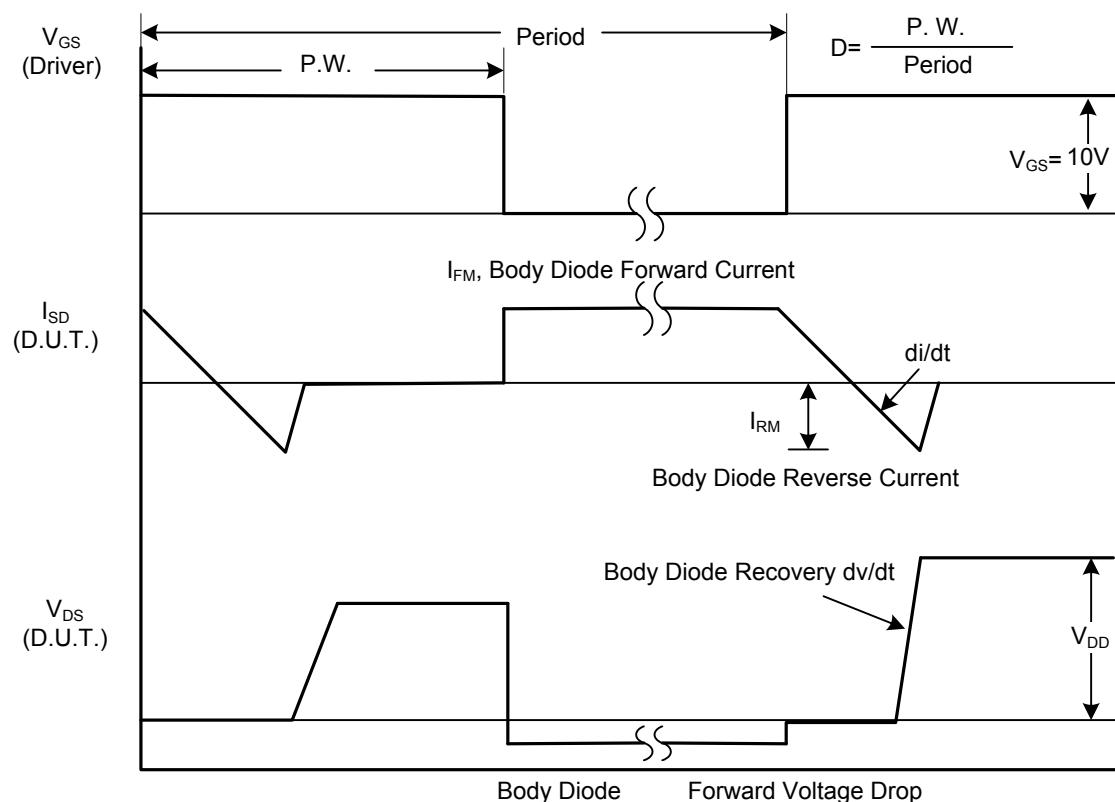
Notes: 1. Pulse Test: Pulse width $\leq 300\mu\text{s}$ , Duty cycle $\leq 2\%$ 

2. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

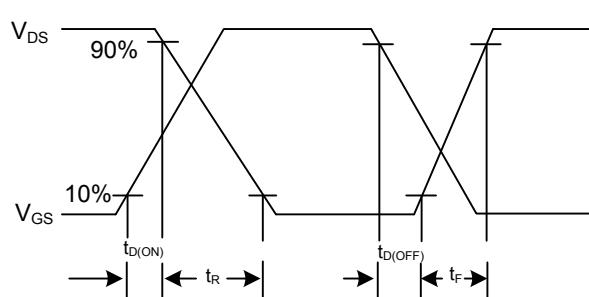
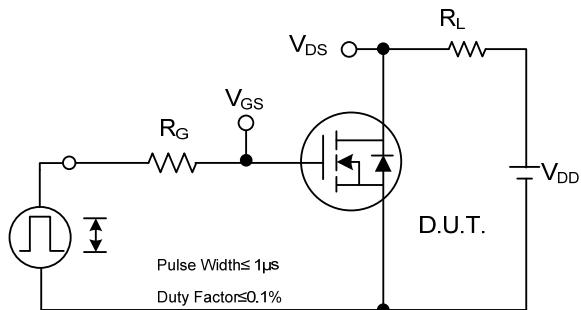


**Peak Diode Recovery dv/dt Test Circuit**



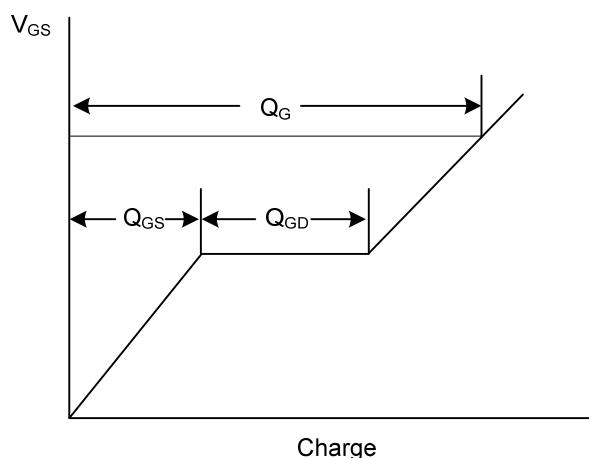
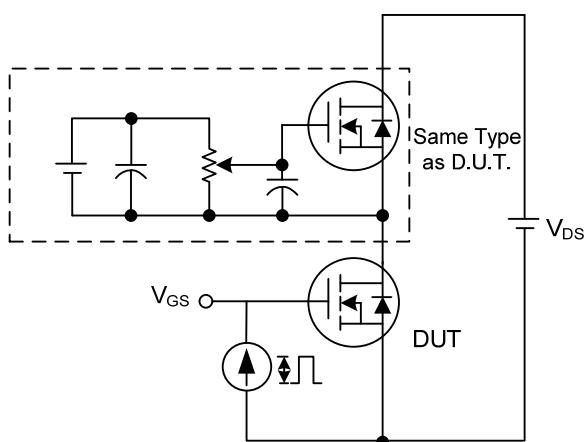
**Peak Diode Recovery dv/dt Waveforms**

### ■ TEST CIRCUITS AND WAVEFORMS



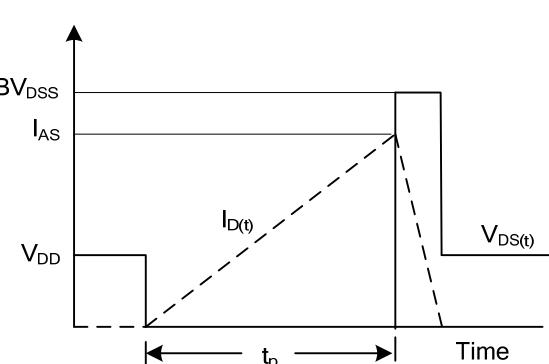
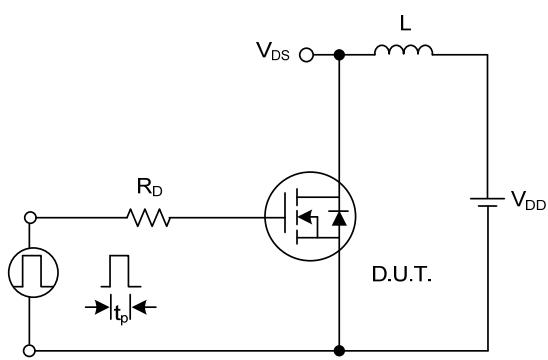
**Switching Test Circuit**

**Switching Waveforms**



**Gate Charge Test Circuit**

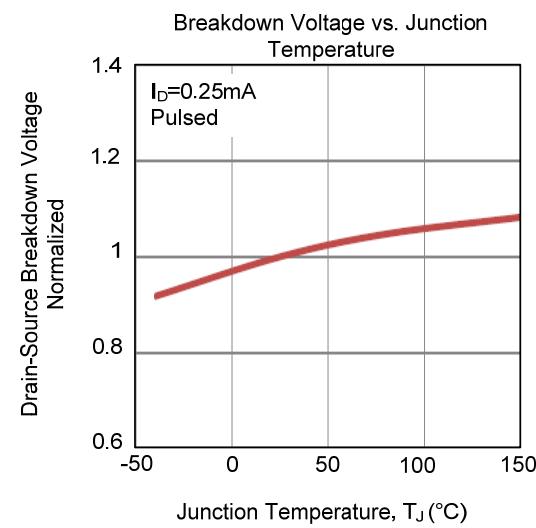
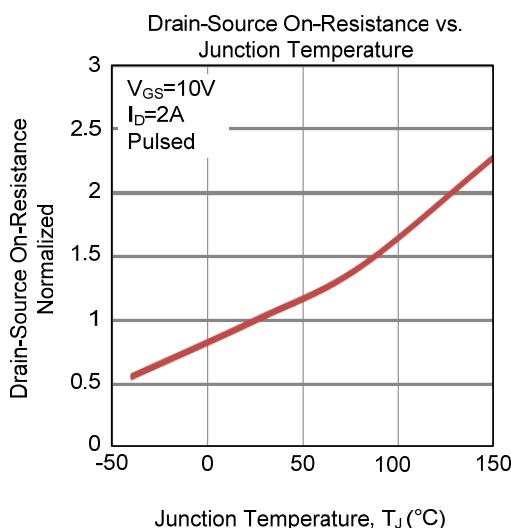
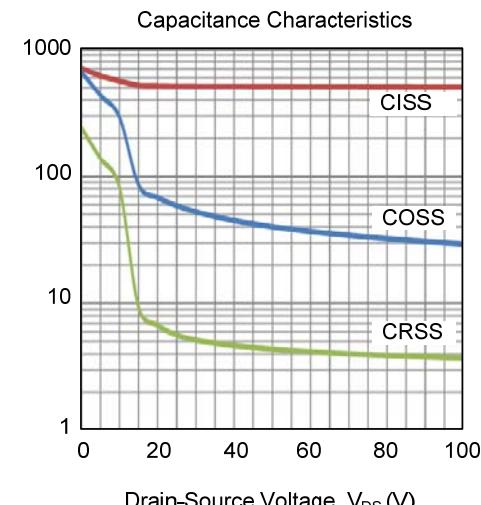
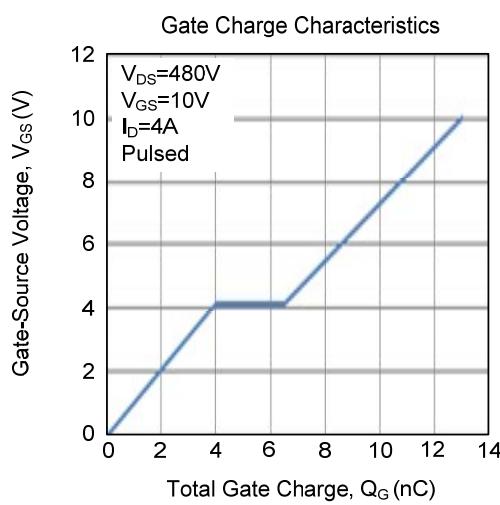
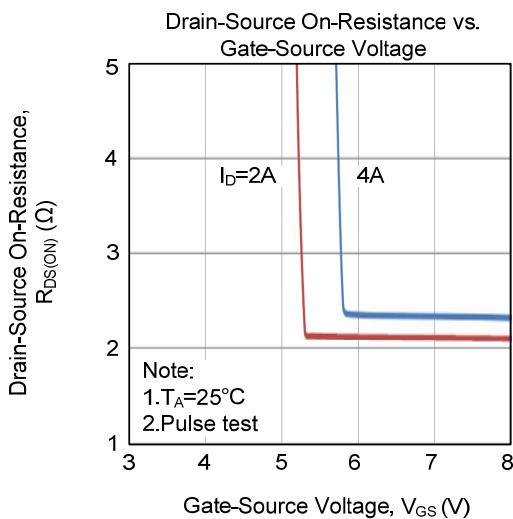
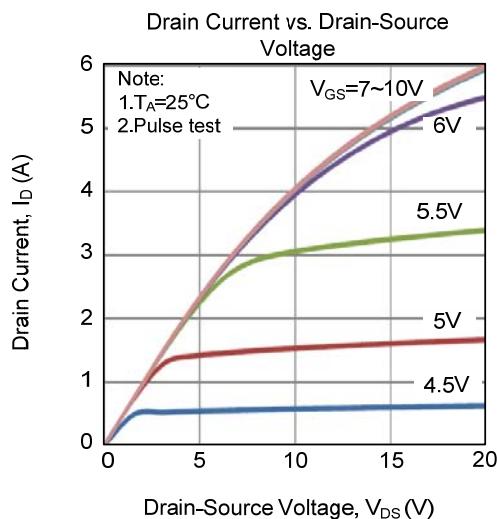
**Gate Charge Waveform**



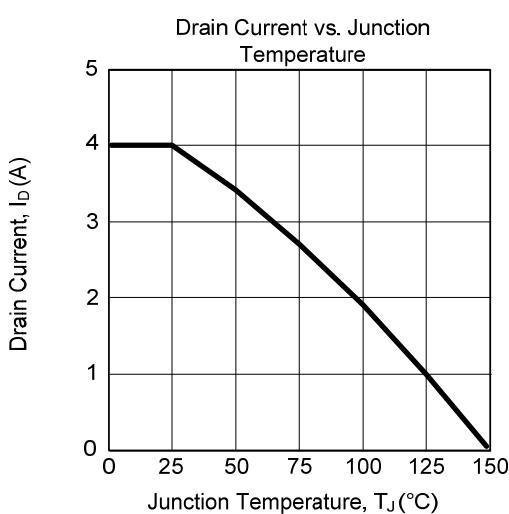
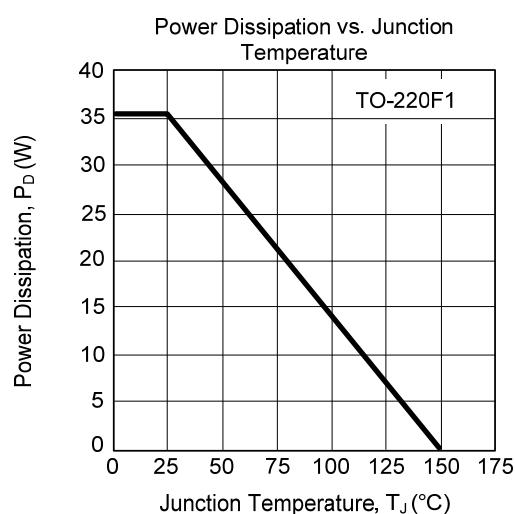
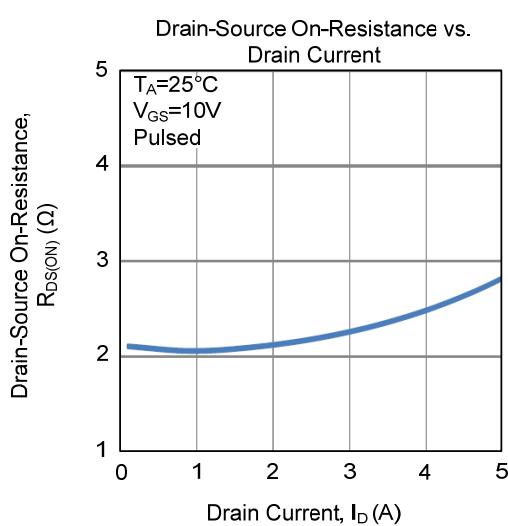
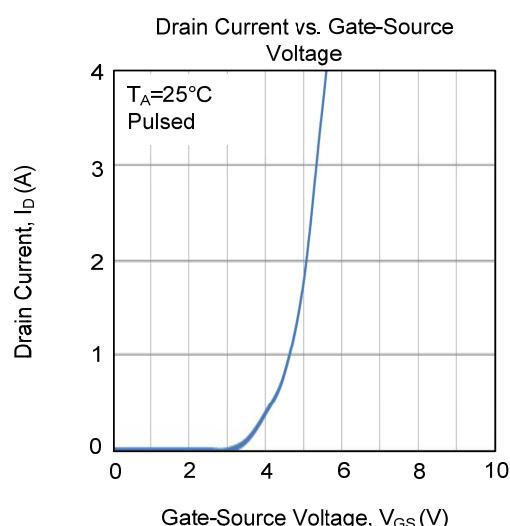
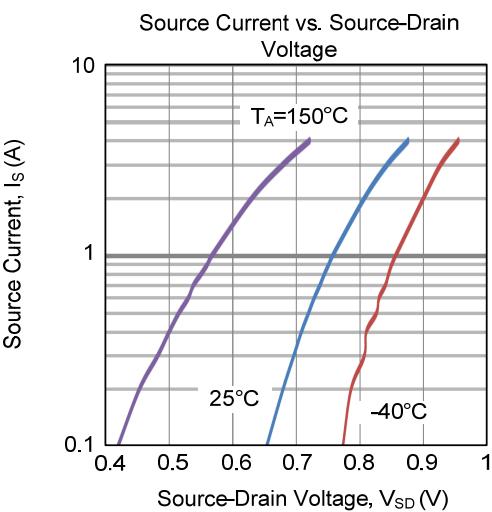
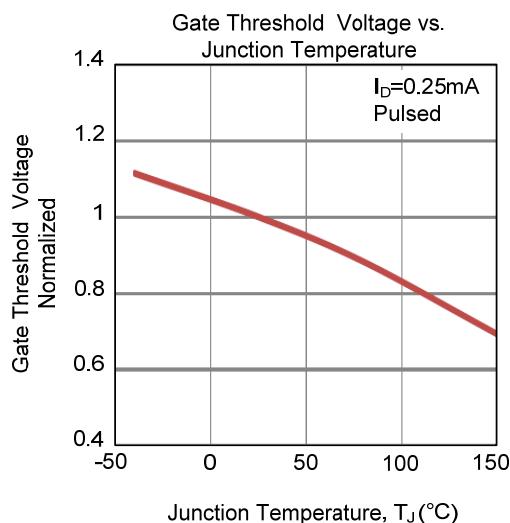
**Unclamped Inductive Switching Test Circuit**

**Unclamped Inductive Switching Waveforms**

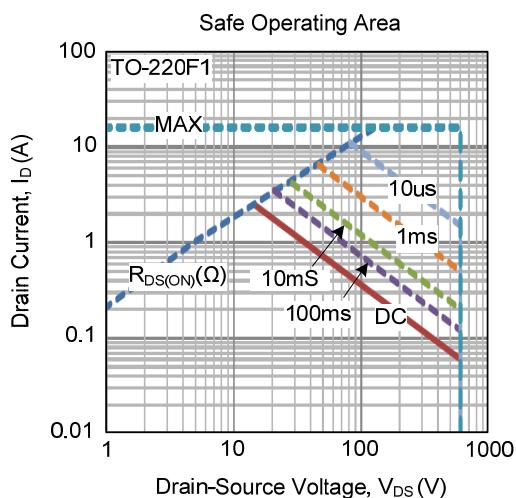
■ TYPICAL CHARACTERISTICS



## ■ TYPICAL CHARACTERISTICS (Cont.)



## ■ TYPICAL CHARACTERISTICS (Cont.)



UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. UTC reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.